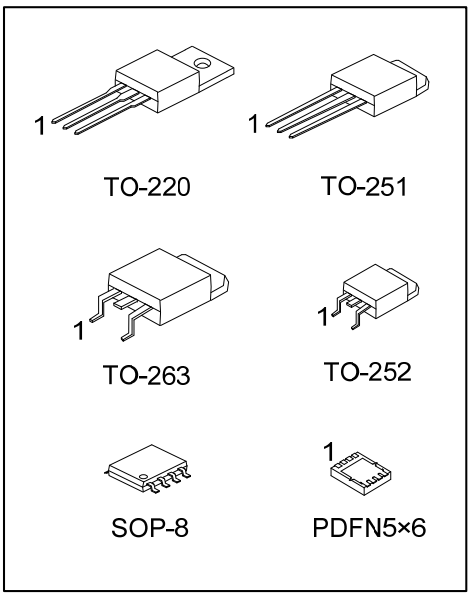
UTT20N06

Power MOSFET

20A, 60V N-CHANNEL POWER MOSFET



■ DESCRIPTION

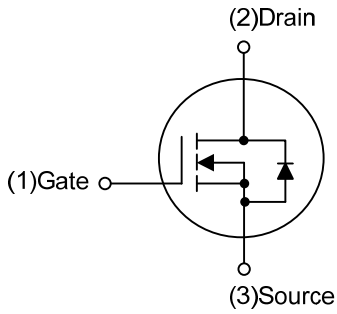
The UTC **UTT20N06** is an N-channel enhancement mode power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **UTT20N06** is universally applied in low voltage, such as automotive, high efficiency switching for DC/DC converters and DC motor control.

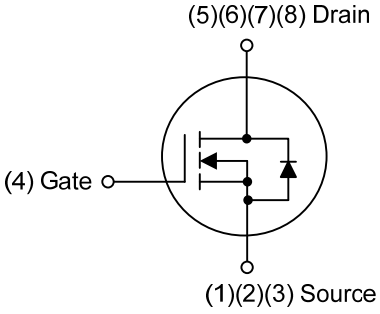
■ FEATURES

* $R_{DS(ON)}$ ≤ 50 mΩ @ V_{GS}=10V, I_D=5.0A
  $R_{DS(ON)}$ ≤ 65 mΩ @ V_{GS}=4.5V, I_D=5.0A
* High switching speed

■ SYMBOL



TO-220/TO-251/TO-252/TO-263

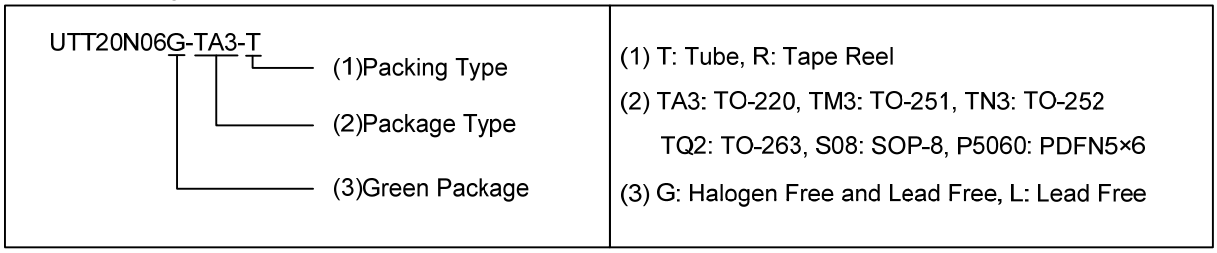


SOP-8/PDFN5×6

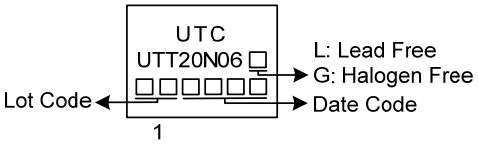
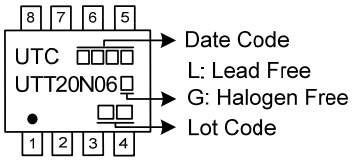
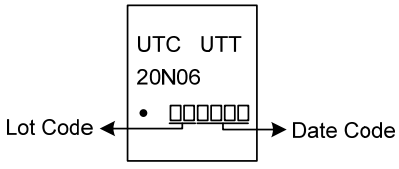
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UTT20N06L-TA3-T	UTT20N06G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
UTT20N06L-TM3-T	UTT20N06G-TM3-T	TO-251	G	D	S						Tube
UTT20N06L-TN3-R	UTT20N06G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UTT20N06L-TQ2-T	UTT20N06G-TQ2-T	TO-263	G	D	S	-	-	-	-	-	Tube
UTT20N06L-TQ2-R	UTT20N06G-TQ2-R	TO-263	G	D	S	-	-	-	-	-	Tape Reel
UTT20N06L-S08-R	UTT20N06G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel
UTT20N06L-P5060-R	UTT20N06G-P5060-R	PDFN5×6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING

PACKAGE	MARKING
TO-220 / TO-251 TO-252 / TO-263	
SOP-8	
PDFN5×6	

■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	60	V
Gate-Source Voltage		V_{GSS}	±20	V
Drain Current	Continuous	I_D	20	A
	Pulsed	I_{DM}	40	A
Power Dissipation	TO-220/TO-263	P_D	89	W
	TO-251/TO-252		50	W
	SOP-8		5.2	W
	PDFN5×6		30	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-263	θ_{JA}	62	°C/W
	TO-251/TO-252		110	°C/W
	SOP-8		100 (Note)	°C/W
	PDFN5×6		35 (Note)	°C/W
Junction to Case	TO-220/TO-263	θ_{JC}	1.4	°C/W
	TO-251/TO-252		2.5 (Note)	°C/W
	SOP-8		24 (Note)	°C/W
	PDFN5×6		4.16 (Note)	°C/W

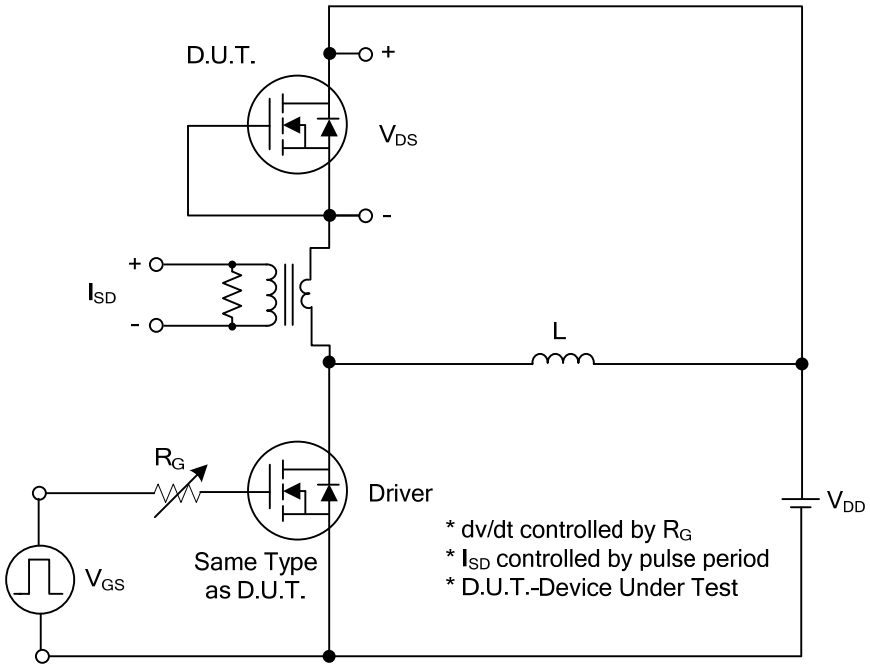
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

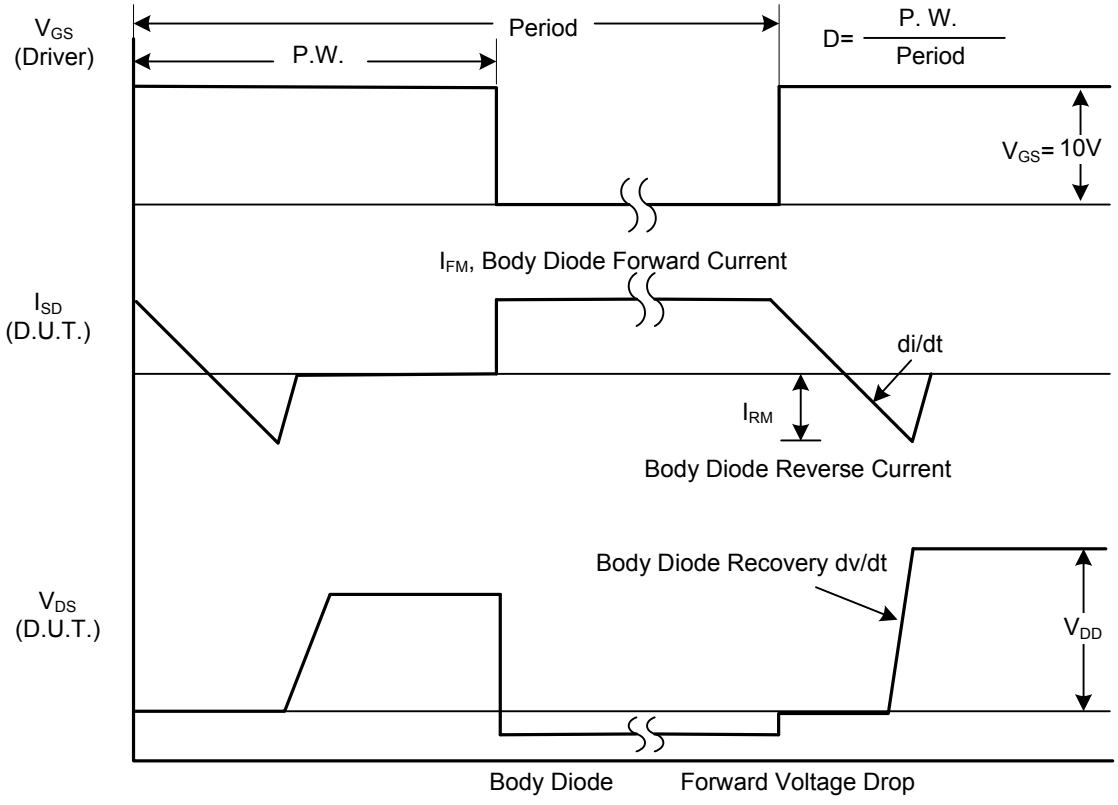
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D=250μA, V_{GS}=0V	60			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=60V, V_{GS}=0V			1	μA
			V_{DS}=48V, V_{GS}=0V, T_C=125°C			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS}=+16V, V_{DS}=0V			+100	nA
	Reverse		V_{GS}=-16V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	1.0		3.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=5.0A			50	mΩ
			V_{GS}=4.5V, I_D=5.0A			65	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{GS}=0V, V_{DS}=25V, f=1.0MHz		676		pF
Output Capacitance		C_{OSS}			70		pF
Reverse Transfer Capacitance		C_{RSS}			51		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	V_{DS}=10V, V_{GS}=48V, I_D=20A I_G=1mA (Note 1, 2)		22		nC
Gate to Source Charge		Q_{GS}			5		nC
Gate to Drain Charge		Q_{GD}			4.5		nC
Turn-ON Delay Time		$t_{D(ON)}$	V_{DS}=30V, V_{GS}=10V, I_D=20A, R_G=3.3Ω (Note 1, 2)		3.2		ns
Rise Time		t_R			17		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			13		ns
Fall-Time		t_F			19		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				20	A
Maximum Body-Diode Pulsed Current		I_{SM}				40	A
Drain-Source Diode Forward Voltage		V_{SD}	I_S=20A, V_{GS}=0V			1.2	V
Reverse Recovery Time		t_{rr}	I_S=20A, V_{GS}=0V, dI/dt=100A/μs		30		nS
Reverse Recovery Charge		Q_{rr}			12		nC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

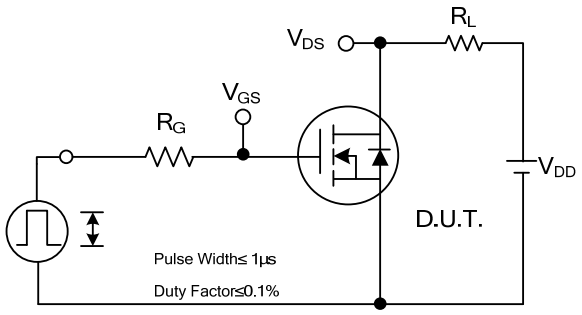


Peak Diode Recovery dv/dt Test Circuit

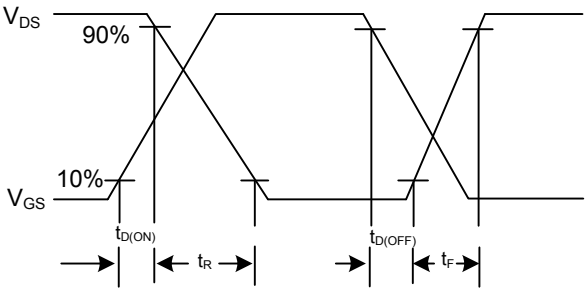


Peak Diode Recovery dv/dt Waveforms

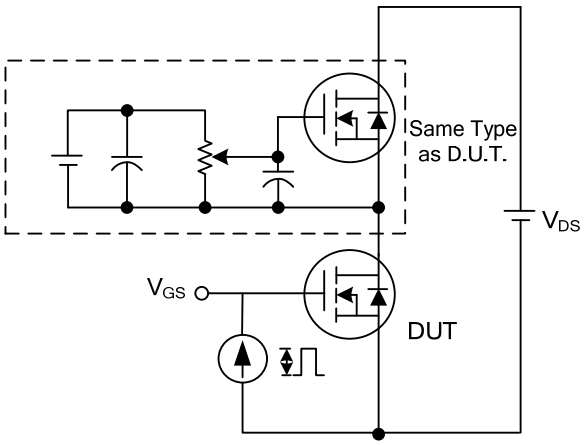
■ TEST CIRCUITS AND WAVEFORMS



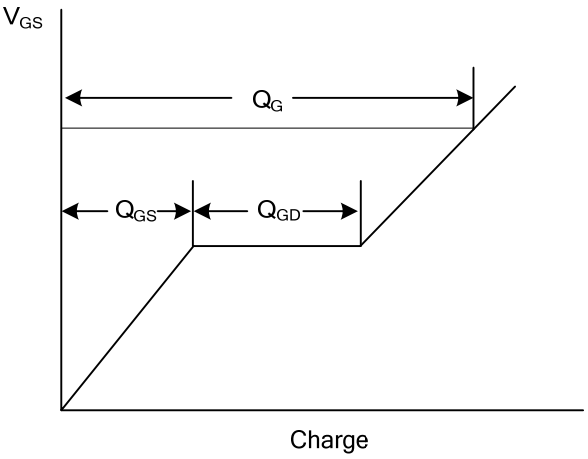
Switching Test Circuit



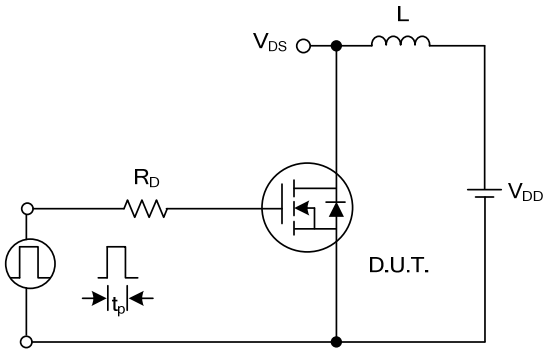
Switching Waveforms



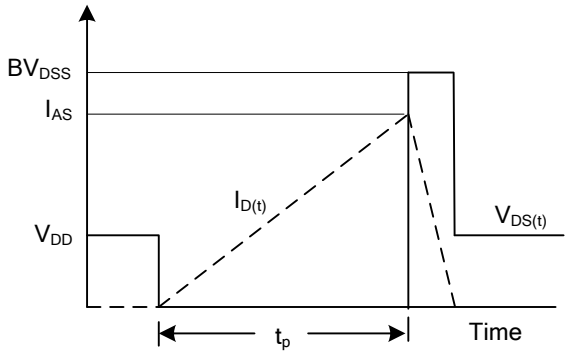
Gate Charge Test Circuit



Gate Charge Waveform



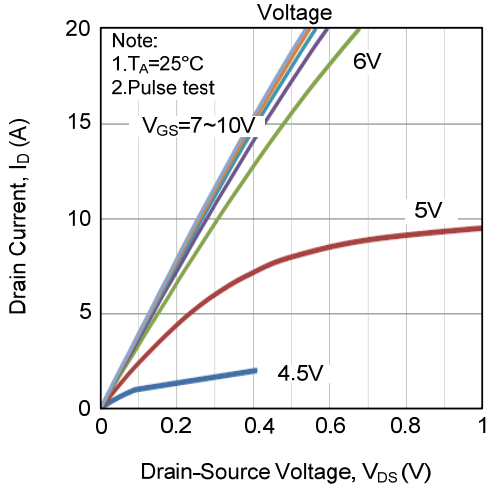
Unclamped Inductive Switching Test Circuit



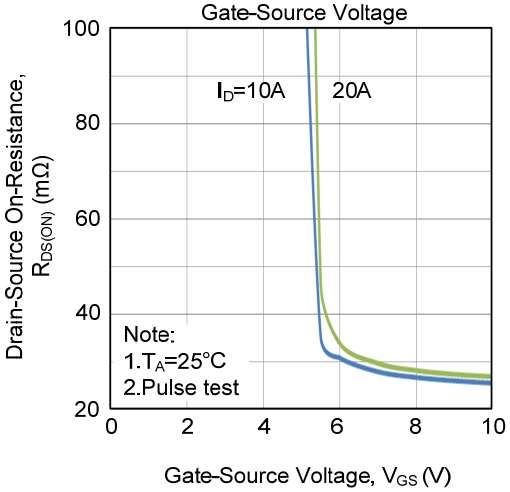
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

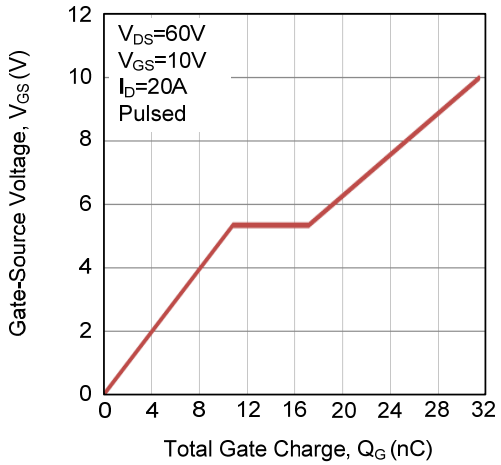
Drain Current vs. Drain-Source Voltage



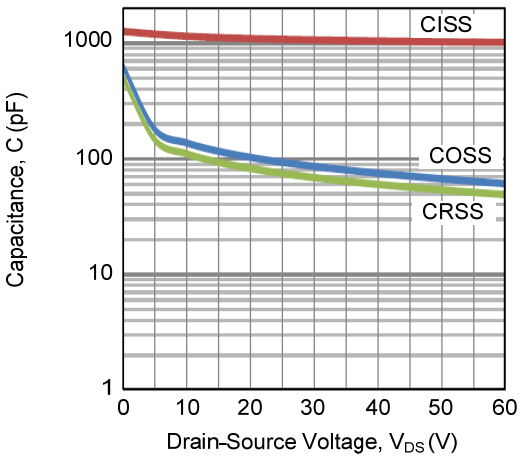
Drain-Source On-Resistance vs. Gate-Source Voltage



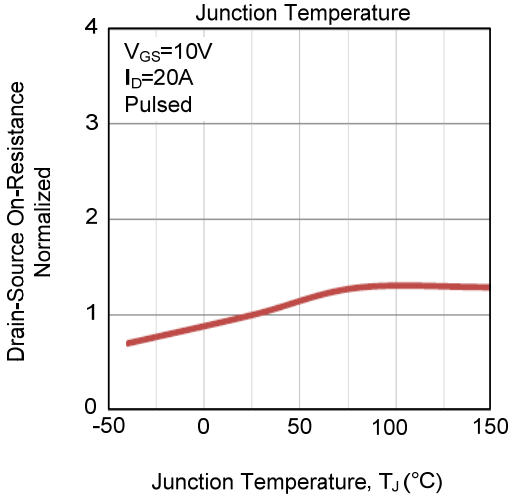
Gate Charge Characteristics



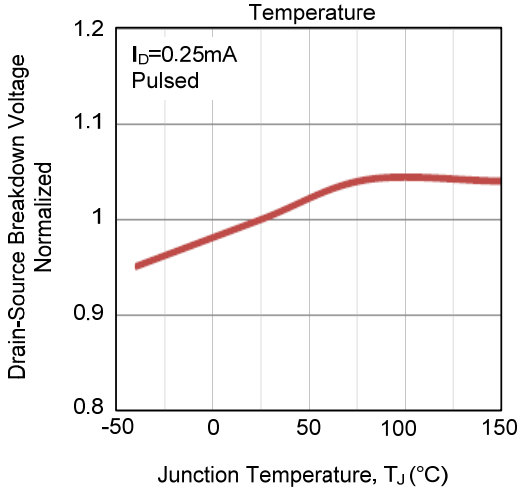
Capacitance Characteristics



Drain-Source On-Resistance vs. Junction Temperature

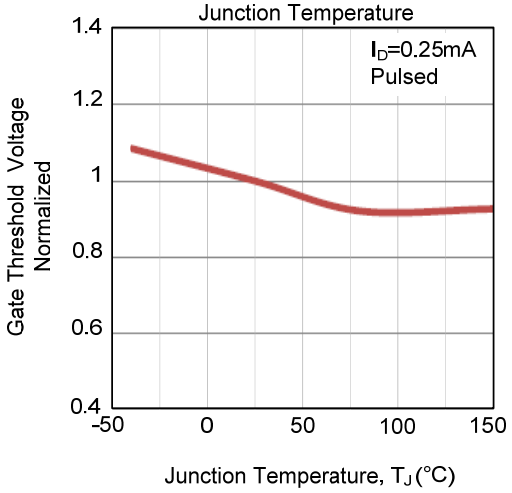


Breakdown Voltage vs. Junction Temperature

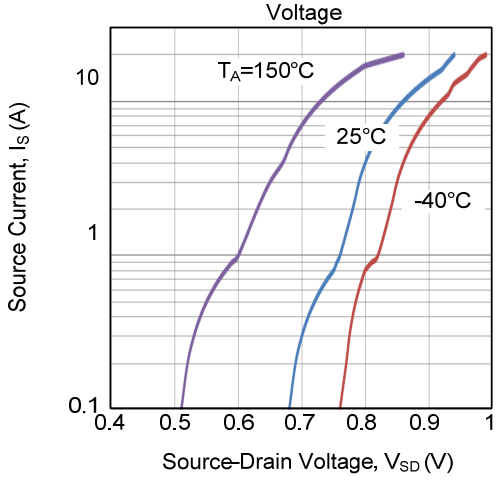


■ TYPICAL CHARACTERISTICS (Cont.)

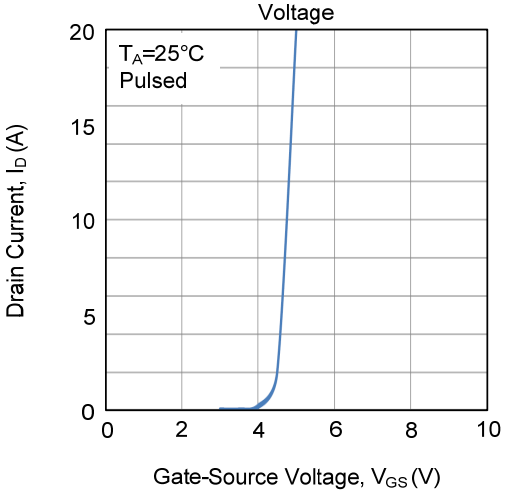
Gate Threshold Voltage vs. Junction Temperature



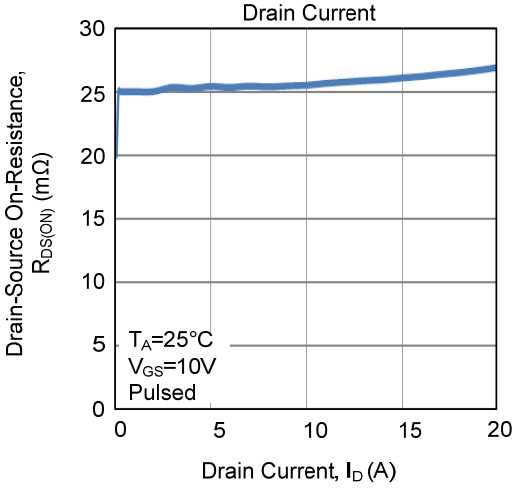
Source Current vs. Source-Drain Voltage



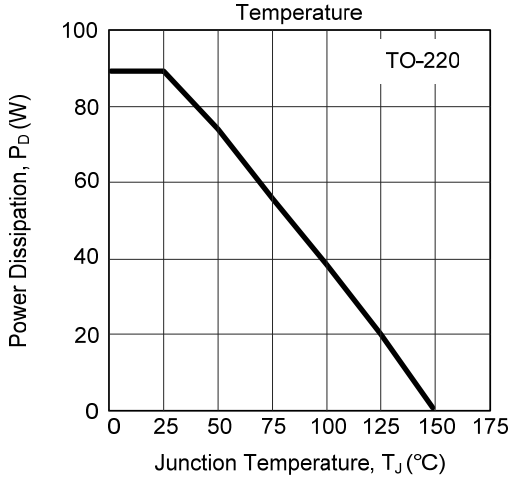
Drain Current vs. Gate-Source Voltage



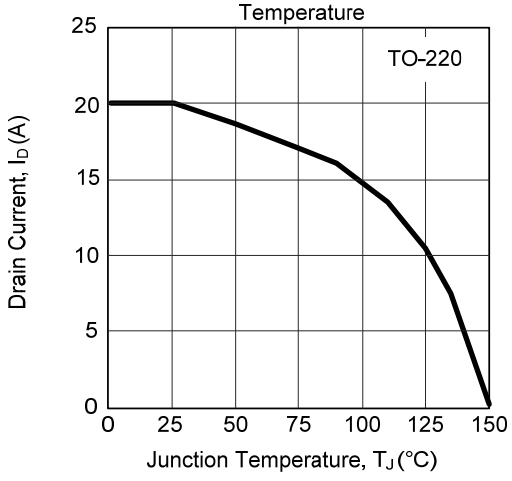
Drain-Source On-Resistance vs. Drain Current



Power Dissipation vs. Junction Temperature



Drain Current vs. Junction Temperature



■ TYPICAL CHARACTERISTICS (Cont.)